

1. General description

High-speed switching diode, encapsulated in a very small and flat lead SOD323F Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: $t_{rr} \le 4$ ns
- Low capacitance
- · Low leakage current
- Reverse voltage: $V_R \le 100 \text{ V}$
- Repetitive peak reverse voltage: V_{RRM} ≤ 100 V
- Small SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High-speed switching
- General-purpose switching

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|-----------------------|---|---|-----|-----|-----|------|
| Per diode | ' | | • | | | | |
| V _R | reverse voltage | | | - | - | 100 | V |
| I _R | reverse current | V _R = 80 V; T _{amb} = 25 °C | | - | - | 0.5 | μA |
| t _{rr} | reverse recovery time | I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C | | - | - | 4 | ns |



5. Pinning information

| Table 2 | Table 2. Pinning information | | | | | | |
|---------|------------------------------|-------------|--------------------|----------------|--|--|--|
| Pin | Symbol | Description | Simplified outline | Graphic symbol | | | |
| 1 | K | cathode | 1 2 | | | | |
| 2 | A | anode | | K-KI-A | | | |
| | | | SC-90 (SOD323F) | 006aab040 | | | |

6. Ordering information

| Table 3. Ordering information | | | | | |
|-------------------------------|---------|---|---------|--|--|
| Type number | Package | | | | |
| | Name | Description | Version | | |
| BAS16J-Q | SC-90 | plastic, surface-mounted package; 2 leads; 1.7 mm x 1.25 mm x 0.7 mm body | SOD323F | | |

7. Marking

| Table 4. Marking codes | | | | |
|------------------------|--------------|--|--|--|
| Type number | Marking code | | | |
| BAS16J-Q | AR | | | |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|--|--|-----|-----|-----|------|
| Per diode | L | | | | | |
| V _{RRM} | repetitive peak reverse voltage | | | - | 100 | V |
| V _R | reverse voltage | | | - | 100 | V |
| l _F | forward current | | [1] | - | 250 | mA |
| I _{FSM} | non-repetitive peak forward current | t _p = 1 μs; square wave; T _{j(init)} = 25 °C | | - | 4 | А |
| | | t _p = 1 ms; square wave; T _{j(init)} = 25 °C | | - | 1 | А |
| | | t _p = 1 s; square wave; T _{j(init)} = 25 °C | | - | 0.5 | А |
| I _{FRM} | repetitive peak forward current | $t_p \le 0.5 \text{ ms}; \delta \le 0.25$ | | - | 500 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [2] | - | 550 | mW |
| Per device | | - | | | | |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -65 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

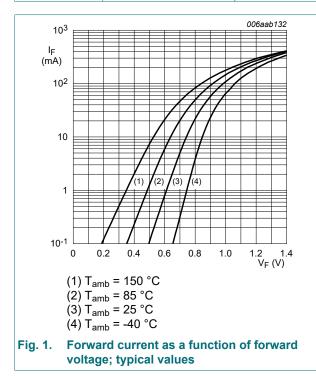
| Symbol | Parameter | Conditions | | Min | Тур | Мах | Unit |
|-----------------------|--|-------------|-----|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | [1] | - | - | 230 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | [2] | - | - | 55 | K/W |

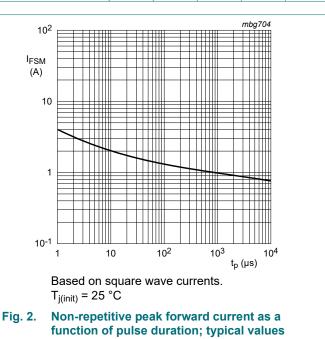
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[2] Soldering point of cathode tab.

10. Characteristics

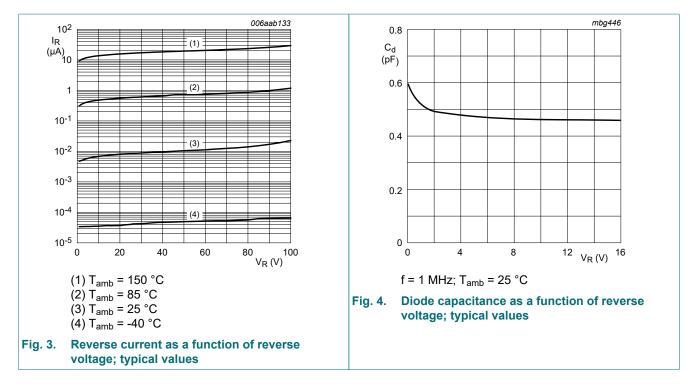
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------|---|-----|-----|------|------|
| Per diode | | · · · · · · | I | | | |
| V _F | forward voltage | $\label{eq:IF} \begin{array}{l} I_{F} = 1 \text{ mA; } t_p \leq 300 \ \mu\text{s}; \ \delta \leq \ 0.02; \\ pulsed; T_{amb} = 25 \ ^\circ\text{C} \end{array}$ | - | - | 715 | mV |
| | | $\label{eq:IF} \begin{array}{l} I_{F} = 10 \text{ mA}; t_{p} \leq \ 300 \ \mu\text{s}; \delta \leq \ 0.02; \\ pulsed; T_{amb} = 25 \ ^{\circ}\text{C} \end{array}$ | - | - | 855 | mV |
| | | $ I_{F} = 50 \text{ mA}; t_{p} \le 300 \mu\text{s}; \delta \le 0.02; $ pulsed; $T_{amb} = 25 ^{\circ}\text{C} $ | - | - | 1 | V |
| | | $ \begin{array}{ll} I_F = 150 \text{ mA; } t_p \leq \ 300 \ \mu s; \ \! \delta \leq \ 0.02; \\ pulsed; T_amb = 25 \ ^\circ C \end{array} $ | - | - | 1.25 | V |
| I _R | reverse current | V _R = 25 V; T _{amb} = 25 °C | - | - | 30 | nA |
| | | V _R = 80 V; T _{amb} = 25 °C | - | - | 0.5 | μA |
| | | V _R = 25 V; T _j = 150 °C | - | - | 30 | μA |
| | | V _R = 80 V; T _j = 150 °C | - | - | 50 | μA |
| C _d | diode capacitance | V _R = 0 V; f = 1 MHz; T _{amb} = 25 °C | - | - | 1.5 | pF |
| t _{rr} | reverse recovery time | I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C | - | - | 4 | ns |
| V _{FRM} | peak forward recovery voltage | $I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{amb} = 25 \text{ °C}$ | - | - | 1.75 | V |





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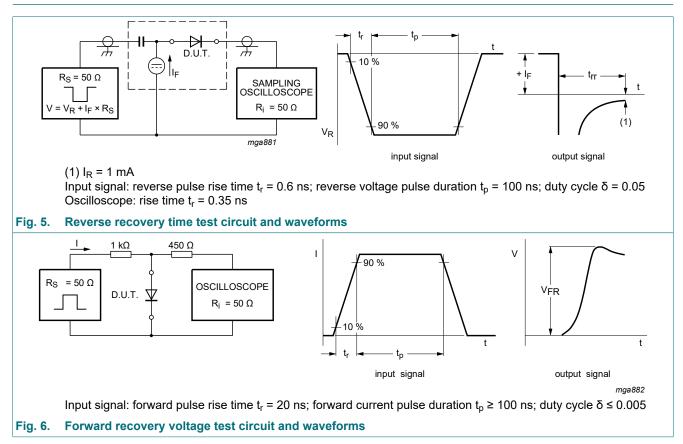
High-speed switching diode



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11. Test information

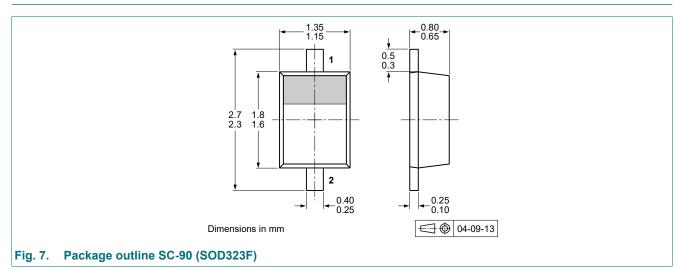


Quality information

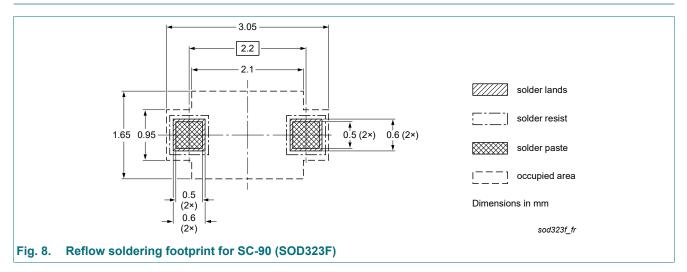
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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12. Package outline



13. Soldering



14. Revision history

| Table 8. Revision history | | | | | |
|---------------------------|--------------|--------------------|---------------|------------|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | |
| BAS16J-Q v.1 | 20210917 | Product data sheet | - | - | |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|-----------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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